NBS PUBLICATIONS

5-3145

Coru: A FORTRAN Program for Charge-Sheet Model Fitting of MOSFET Data

L.C. Witte

Reference

U.S. DEPARTMENT OF COMMERCE National Bureau of Standards National Engineering Laboratory Center for Electronics and Electrical Engineering Semiconductor Electronics Division Gaithersburg, MD 20899

November 1985

HB3 RESEARCH INFORMATION CENTER

NBSIR 85-3145

CSFIT: A FORTRAN PROGRAM FOR CHARGE-SHEET MODEL FITTING OF MOSFET DATA

L.C. Witte

U.S. DEPARTMENT OF COMMERCE National Bureau of Standards National Engineering Laboratory Center for Electronics and Electrical Engineering Semiconductor Electronics Division Gaithersburg, MD 20899

November 1985

Prepared for Defense Nuclear Agency Washington, DC 20305



U.S. DEPARTMENT OF COMMERCE, Malcolm Baldrige, Secretary NATIONAL BUREAU OF STANDARDS, Ernest Ambler, Director

.

Table of Contents

																						Pa	ge
Ał	ostract	•	•	•	•	•	•	•	•	•	•		•	•	•	•	•	•	•	•			1
1.	Introduction	•	•	•		•	•		•	•	•	•	•			•	•	•	•	•			1
2.	Theory	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•		•	2
3.	Computer Implementation	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	4
	A. Software Modules	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•		•	4
	B. Limitations	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	7
4.	Example Execution	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•			•	7
5.	Conclusions	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	8
6.	Acknowledgments	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	17
7.	References	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	17
A	ppendix A: Definition of Parameters	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	٠	18
A	ppendix B: Example Execution Files				•	•	•	•	•	•	•				•						•	٠	19

List of Figures

1.	CSFIT computer program sections and subroutine flow diagram
2.	CSFIT results compared to measured data for an unirradiated transistor $V_d = 0.25 \text{ V} \dots $
3.	CSFIT results compared to measured data for a 10 krad(Si) dose, $V_d = 0.25 \text{ V} \dots $
4.	CSFIT results compared to measured data for a 50 krad(Si) dose, $V_d = 0.25 \text{ V} \dots $
5.	CSFIT results compared to measured data for a 100 krad(Si) dose, $V_d = 0.25 \text{ V} \dots $
6.	CSFIT results compared to measured data for a 500 krad(Si) dose, $V_d = 0.25 \text{ V} \dots $

7.	The linear region characteristics from the charge-sheet model and the fitted values of mobility and flatband voltage, as a function of dose.
	compared to measured data, $V_d = 0.25$ V
8.	Charge-sheet model characteristics in the saturated region using the fitted parameter compared to measured data for an unirradiated transistor 15
9.	Charge-sheet model characteristics in the saturated region using the fitted parameter compared to measured data for a 100 krad(Si) dose

.

.

.

.

CSFIT: A FORTRAN Program for Charge-Sheet Model Fitting of MOSFET Data

L. C. Witte Semiconductor Electronics Division National Bureau of Standards Gaithersburg, MD 20899

ABSTRACT

A FORTRAN program, CSFIT, has been developed for fitting an expression for the current-voltage (I-V) characteristics of a long-channel MOSFET to experimental I-V curves. The one-dimensional charge-sheet model developed by Brews provides the basis for the I-V characteristics. The I-V characteristics given by this model are optimized with respect to a set of experimental data using the flatband voltage and the mobility as the only adjustable parameters. The program is written so that multiple sets of I-V data can be fit simultaneously if desired. The user must supply, in specified formats, a current-voltage data file, a device parameter file, and a starting value file.

KEY WORDS: charge-sheet model; flatband voltage; I-V characteristics; mobility; MOSFET; parameter extraction

1. INTRODUCTION

A FORTRAN program, CSFIT, has been developed for fitting an expression for the current-voltage (I-V) characteristics of a long-channel metal-oxide-semiconductor field-effect transistor (MOSFET) to experimental I-V curves. The sign convention adopted is appropriate for n-channel enhancement-mode devices. The one-dimensional charge-sheet model developed by Brews [1] provides the basis for the I-V characteristics. The I-V characteristics given by this model are optimized with respect to a set of experimental data using the flatband voltage and the mobility as the only adjustable parameters.

The program CSFIT executes the optimization according to the least squares criterion using a subroutine STEPIT, developed by J.P. Chandler [2]. STEPIT finds a local minimum of any given smooth function of several parameters. CSFIT reads in dc MOSFET I-V data and physical device parameters and then calls the subroutine STSET for the initialization of the STEPIT input parameters. STEPIT performs the minimization of the specified current model. The subroutine MODEL, called by STEPIT, uses the current equation derived by Brews [1]. The MODEL routine then calls the subroutine CS0. The CS0 and FUNCTION subroutines, developed by C. L. Wilson [3], solve for the potential along the oxide-silicon surface at the drain and source end of the channel needed to determine the drain current. The subroutine FUNCTION is called by CS0 to determine the actual drain current once the potential at the drain and source has been determined. In section 2, a brief discussion of the formulation of the charge-sheet model is presented. In particular, the current equation is given along with a discussion of the method of solving for the boundary conditions of the potential along the oxide-silicon surface for a given gate voltage and drain voltage. The current equation and the boundary conditions are precisely what the CS0 computer code solves.

In section 3, the specific procedures needed to implement CSFIT are discussed. The function of each of the principal subroutines is outlined. Limitations of the program are discussed.

In section 4, verification of CSFIT is presented. An example of usage is demonstrated by optimizing the flatband voltage and mobility when radiation-induced interface effects are present. The optimized values are then used to generate current-voltage curves in the subthreshold, linear, and saturated regions of MOSFET operation. The input files used to obtain the optimized parameters and the output file results are given in Appendix B. A print-out of the CSFIT computer program is given in Appendix C.

2. THEORY

The charge-sheet model of the MOSFET assumes that the carrier density in the inversion layer is contained in a charge sheet of zero thickness. Thus, the current is constrained to flow along the oxide-silicon interface and there is no voltage drop across the inversion layer. For long-channel devices, it can be assumed that Poisson's equation must be solved in one dimension only because the potential variations along the channel are gradual compared to those normal to the channel. The discontinuity condition across the oxide-silicon interface is then applied, implying that the carrier density per unit area N(y) is contained in a charge sheet of zero thickness. The coordinate system used measures "y" along the channel of a MOSFET from the source toward the drain, "z" along the width of the drawn gate, and "x" perpendicular to the plane of the gate.

Using an arbitrary potential along the oxide-silicon surface $\phi(x = 0, y)$, Poisson's equation for the potential in the oxide and the semiconductor can be solved. Then, with a derived equation for N(y) (refer to Brews for details [1]), an integral equation for the surface potential is obtained. This equation is then solved, with the resulting drain current given by

$$I = \frac{1}{\beta} \mu^* \left(\frac{Z}{L}\right) \{C_{oz} \left(1 + \beta V_G\right) \left(\phi_{SL} - \phi_{S0}\right) - \frac{\beta}{2} C_{oz} \left(\phi_{SL}^2 - \phi_{S0}^2\right) - q N_A L_B \left(\frac{2\sqrt{2}}{3}\right) \left[\left(\beta \phi_{SL} - 1\right)^{3/2} - \left(\beta \phi_{S0} - 1\right)^{3/2} \right] + q N_A L_B \sqrt{(2)} \left[\left(\beta \phi_{SL} - 1\right)^{1/2} - \left(\beta \phi_{S0} - 1\right)^{1/2} \right] \},$$
(11)

where $\phi_{SL} = \phi_S(L)$ and $\phi_{S0} = \phi_S(0)$. This is eq (11) in the paper by Brews [1]. Definitions of the parameters used in eq (11) are given in Appendix A. The value of ϕ_{S0} and ϕ_{SL} for a given gate voltage V_G and drain voltage V_D must be known before the current eq (11) can be solved.

At the source end of the channel, ϕ_{S0} is taken from the one-dimensional Poisson equation for zero drain voltage with $(\beta\phi_{S0}-1) \gg \exp(-\beta\phi_{S0})$, yielding

$$C_{ox}(V_G - \phi_{S0}) = q N_A L_B \sqrt{2} \left[\beta \phi_{S0} - 1 + \left(\frac{n_i}{N_A}\right)^2 e^{\beta \phi_{S0}} \right]^{1/2}, \qquad (12)$$

which is eq (12) in Brews' paper. Equation (12) can be rearranged to provide an algorithm for ϕ_{50} . The iterative form becomes

$$\phi_{S0}^{i+1} = \phi_{S0} + \frac{1}{\beta} ln \{ \left[\beta (V_G - \phi_{S0}^i) \right]^2 / \left[1 + (\beta \phi_{S0}^i - 1) / \exp \beta (\phi_{S0}^i - 2\phi_B) \right] \},$$
(13)

where ϕ_{S0}^{i} is the *i*th trial value for ϕ_{S0} and the initial trial value is

$$\phi_{S0} = 2\phi_B - \frac{2}{\beta} ln \left[\beta \frac{\sqrt{2}q N_A L_B}{C_{ox}} \right].$$

Once the iterative algorithm for the potential at the source has converged, the resulting potential can be used in the current equation.

To determine the potential at the drain end of the channel, for a given V_D and V_G , eqs (14), (16), and (17) from the paper by Brews [1] were used. These equations are as follows:

$$qN(o) = qN_A L_B \sqrt{2} \left\{ \left[\beta \phi_{S0} - 1 + \left(\frac{n_i}{N_A} \right)^2 e^{\beta \phi_{S0}} \right]^{1/2} - (\beta \phi_{S0} - 1)^{1/2} \right\}$$
(14)

$$\beta \phi_{SL} = \beta \phi_{S0} + \beta V_D + ln \left[\frac{N(L)}{N(o)} \right]$$
(16)

$$qN(L) = C_{oz}(V_G - \phi_{SL}) - qN_A L_B \sqrt{2} (\beta \phi_{SL} - 1)^{1/2}.$$
 (17)

Using eqs (14) and (17) in (16) results in a value for the potential at the drain end of the channel. With the source and drain potentials, ϕ_{S0} and ϕ_{SL} , the current eq (11) can be solved. Equation (11) is the function used to be minimized in the optimization routine.

3. COMPUTER IMPLEMENTATION

A. SOFTWARE MODULES

In order to run the program, the user should carry out the following steps. The user needs to obtain a copyrighted copy of STEPIT from the distributing organization^{*} and create three input files in the required format. After creating the three input files, the user will need to link CSFIT to STEPIT. Once the routines are linked, the user may then proceed to execute the optimization routine. The program will then prompt the user for the I-V data file name, the device parameter file name, the initial starting value file name, and finally, the desired output result file name. This sample set of linkage control statements has been used to execute the CSFIT program on the DEC VAX 11/780 under the VMS system.

The computer program, CSFIT, consists of three sections: a data input and initialization section, a fitting program, STEPIT, developed by J.P. Chandler [2], and a model section, as shown in figure 1. In the following paragraphs of this section, a circled number refers to an encircled step on the flow-diagram given in figure 1.

The input section of CSFIT consists of the input routine (1) and STSET (2). The input routine reads in measured dc transistor data and known device parameters. This routine normalizes device parameters. The STSET subroutine, developed by Chandler [2], reads in constraints on the minimization process and sets controlling parameters for the fitting routine STEPIT.

The fitting section uses STEPIT ③ to minimize the objective function subject to the constraints imposed by the user. The method used in STEPIT is an accelerated version of the 'cyclic variation' or 'one-variable-at-a-time' method. First, each fitting parameter x(j) is varied individually. If progress is made by finding a lower value of the objective function, the step size is doubled. However, the number of steps in this phase is limited. When a local minimum has been found, quadratic interpolation is used in an attempt to refine the position of the minimum. The minimum point is never shifted unless a better (lower) value of the objective function is found.

Once each of the x(j) has been varied, attempts are made to move along the resultant of all of these individual displacements. Doubling of the step size follows each successful step, this time with no limit on the number of steps. Quadratic interpolation again follows. STEPIT consists of several subprograms which are referenced in [2].

The model section consists of the subroutines MODEL ④, CSO ⑤, and FUNCTION ⑥. The CSO subroutine solves the charge-sheet equations for the potentials at the drain and source end of the channel, passing the values to FUNCTION which calculates the drain-to-

^{*} STEPIT is available from the Quantum Chemistry Program Exchange, Indiana University, Bloomington, IN 47401.



Figure 1. CSFIT computer program sections and subroutine flow diagram.

source current. The calculated current is passed via 7 and 3 to the MODEL subroutine, which generates an objective function which is the sum of the squares of the differences between the measured and charge-sheet model drain currents. The STEPIT subroutine receives the objective function via 9 and proceeds to 10 to determine if the convergence tolerance on minimization is satisfied. When the convergence tolerance is satisfied, CSFIT is finished. If the convergence tolerance is not satisfied, steps 4 to 9 are repeated.

The first file is the current-voltage (IV) data file. The data are read into an (npts) x 3 array, where npts is the total number of points in all of the data sets. CSFIT, without any modifications, assumes that the measured source-to-drain voltage for each data set is in npts x 1, the measured drain current is in npts x 2, and the measured gate voltage is in npts x 3. This specific format can easily be changed to meet the user's needs if so desired. Thus, the required I-V data file would be as follows:

npts = the total number of data points

The second file is the device parameter file. The following format is required:

nvds	= the number of data sets
vds(l)	= source-to-drain voltages for each data set
vds(i)	i=1,nvds
npset(l)	= number of data points in each set
npset(i)	i=1,nvds
nch	= average channel doping (cm ³)
tox	= oxide thickness (cm)
ljun	= lateral source and drain diffusion under the gate (cm
lch	= drawn length of polysilicon (cm)
Z	= width of channel (cm)

The third file is the initial starting value file, with the following required format:

initial fbv(1) initial mob(1) initial fbv(2) initial mob(2) initial fbv(nvds) initial mob(nvds)

The initial values of flatband voltage (fbv(i)) must be equal to or less than zero. The subroutine STSET is an initialization subroutine for the actual optimization routine STEPIT. STSET allows the user to set the following controlling parameters:

x(i) = initial values of the fitting parameter, on which the function to be minimized depends.

xmax(i)	=	the upper limit on the value of $x(i)$.
xmin(i)	=	the lower limit on the value of $x(i)$.
deltx(i)	=	the initial step by which $x(i)$ is varied.
delmn(i)	=	the lower limit (convergence tolerance) on the step size for $x(i)$.
mask(i)	=	set nonzero if x(i) is not to be varied, but rather is to be held at its
		initial value.
ntrac	=	determines the amount of printout from STEPIT.
		ntrac=1 to obtain trace during the minimization process
		ntrac=0 for initial and file output only
		ntrac=-1 for no output except error messages

STSET will set all the above to default value except ntrac; i.e., ntrac must be set by the user. Without modification, CSFIT is written with the above parameters set to the following values:

x(i)	=	initial starting value file
xmax(i)	=	default value of +1.0E+35
xmin(i)	=	default value of -1.0E-35
deltx(i)	=	default value of $x(i)/10$
delmn(i)	=	1.0E-04
mask(i)	=	default value of 0
ntrac	=	1

The user need not be concerned with modification of the controlling parameters unless a fitting parameter is desired to be held constant (mask(i)=1), or a fitting parameter is desired to be held within a smaller range of values.

B. LIMITATIONS

Often, the error subroutines in STEPIT cannot be computed. The error routines sometimes start with poor initial starting values for the CSO algorithm, resulting in the square root of a negative number. If this occurs, the computed results should be considered valid.

If the CSFIT routine is given poor initial starting values for the fitting parameters, the CSO algorithm will result in a square root of a negative number, and hence, the user must correct initial starting values.

4. EXAMPLE EXECUTION

In this section, CSFIT is demonstrated using results obtained with an irradiated n-channel enhancement-mode MOSFET. Prior to irradiation and after irradiation exposure to 10, 50, 100, and 500 krad(Si), the current-voltage characteristics of the transistor were measured. All devices were biased with +9 V on the gate and source, drain, and substrate grounded. The parameters used in the simulation are given in Table 1. Techniques for determining these parameters have been discussed in the literature [4].

Table 1

Device Parameters

L_{ch}	$6.42 \mu m$
V_G, V_D	0.5 to 5.0 V, 0.25 V
toz	0.056µm
n _{ch}	$1 imes 10^{16}/cm^3$
Ljun	$0.70 \mu m$
Z	$16.96 \mu m$

Fitted values for the flatband voltage and mobility were obtained simultaneously for the 0, 10, 50, 100, and 500 krad(Si) doses, and then were used in the charge-sheet model to generate model I-V curves.

Comparison of the charge-sheet model fitted values with measured data shows good agreement in the subthreshold region, the linear region, and the saturation region. Figure 2 compares the fit to measured data for an unirradiated sample. In figure 3, the fit after a 10 krad(Si) dose is compared to measured data. In figure 4, the fit after a 50 krad(Si) dose is compared to measured data. As the dose is increased above 50 krad(Si), the effects of the interface trapped charge energy distribution become important. As shown in figures 5 and 6, for devices irradiated at 100 krad(Si) and 500 krad(Si), respectively, the accuracy of the model degrades with increased irradiation dose.

The linear region I-V characteristics generated from the charge-sheet model and the fitted values of mobility and flatband voltage are compared to measured data as a function of dose in figure 7. Linear region results obtained are in good agreement with measured results.

Charge-sheet model I-V curves in the saturation region using the fitted parameters are compared to measured data in figure 8 for an unirradiated sample. Figure 9 gives a similar plot after a 100 krad(Si) dose.

5. CONCLUSIONS

A fitting program has been developed to provide an optimum set of parameter values for flatband voltage and mobility for a long-channel MOSFET based on the charge-sheet model formulated by Brews [1]. This fitting procedure has been demonstrated using data from an n-channel enhancement-mode MOSFET exposed to ionizing radiation.

6. ACKNOWLEDGMENTS

The author would like to thank C. L. Wilson and K. F. Galloway for their assistance and guidance in preparing this work. Also, I would like to thank M. Gaitan, P. Roitman, and



Figure 2. CSFIT results compared to measured data for an unirradiated transistor, $V_d=0.25$ V.



Figure 3. CSFIT results compared to measured data for a 10 krad(Si) dose, $V_d=0.25$ V.



Figure 4. CSFIT results compared to measured data for a 50 krad(Si) dose, $V_d=0.25$ V.



Figure 5. CSFIT results compared to measured data for a 100 krad(Si) dose, $V_d=0.25$ V.



Figure 6. CSFIT results compared to measured data for a 500 krad(Si) dose, $V_d=0.25$ V.



Figure 7. The linear region characteristics from the charge-sheet model and the fitted values of mobility and flatband voltage, as a function of dose, compared to measured data, $V_d=0.25$ V.



Figure 8. Charge-sheet model characteristics in the saturated region using the fitted parameter compared to measured data for an unirradiated transistor.



Figure 9. Charge-sheet model characteristics in the saturated region using the fitted parameter compared to measured data for a 100 krad(Si) dose.

T. J. Russell for the experimental I-V data and the physical data used in this report. Special thanks go to E. J. Walters for preparing the manuscript.

7. REFERENCES

- 1. Brews, J. R., A Charge-Sheet Model of the MOSFET, Solid-State Electronics 21, 345-355 (1978).
- 2. Chandler, J. P., STEPIT: Minimizing or Maximizing a Function, Department of Computing and Information Sciences, Oklahoma State University, Stillwater, OK 74074.
- 3. CS0 is used to provide an initial guess in the CS1 program. CS0 is reproduced here as part of CSFIT. See: C. L. Wilson and J. L. Blue, CS1: A Two-Dimensional Finite Element Charge-Sheet Model of a Short-Channel MOS Transistor, NBSIR 82-2471 (April 1982).
- 4. Wilson, C. L., Roitman, P., and Blue, J. L., High Accuracy Physical Modeling of Submicron MOSFETs, *IEEE Trans. Electron Devices* ED-32, 1246-1258 (July 1985).

Appendix A: Definition of Parameters

 $\phi_{SL} = \phi_S(L)$ = the potential at the drain end of the channel $\phi_{S0} = \phi_S(0)$ = the potential at the source end of the channel n_{ch} = average channel doping

 $\beta = \frac{q}{kT}$

 $n_i =$ intrinsic carrier concentration

 $\phi_B = \beta ln\left(\frac{N_A}{n_i}\right) = \text{bulk Fermi potential}$ $L_B = (\text{Debye Length}) = \left(\frac{kT\kappa_{ox}\epsilon_0}{q^2N_A}\right)^{1/2}$ $C_{ox} = \text{oxide capacitance per unit area}$

 $t_{ox} =$ oxide thickness

 $L_{ch} = \text{channel length} = L_{poly} - 2L_{jun}$

 $L_{poly} = \text{gate poly length}$

 $L_{jun} =$ lateral junction depth

Z =channel width

 $\mu^* = \text{effective mobility (fitting parameter)}$

 V_{FB} = flatband voltage (fitting parameter)

 $V_G = gate voltage$

 $V_D =$ drain voltage

APPENDIX B: Example Execution Files

The following three required files, (1) I-V data file, (2) parameter file, and (3) initial starting value file, were used to obtain the verification results, with the (4) resulting output file included. The I-V data file used consisted of 403 points. There was a total of five data sets, one set for each radiation dose. The files were as follows:

(1) I-V data file

403					
0.27147	8.597500E-01	1.299160E-08	V_d	V_g	I_D
•	•	•			
•	•	•			
0.25198	7.079650E-01	1.428790E-09			
•	•	•			
•		•			
0.25165	6.080440E-01	1.564180E-09			
•	•	•			
	•	•			
0.25048	4.591630E-01	1.422954E-09			
•	•	•			
•	•	•			
0.25079	9.345300E-01	3.364700E-09			
•	•	•			

. .

(2) paran	aeter file
5	i
0.10	$V_d(i)$
0.25	
0.5	
1.0	
2.0	
04 67	mpts(1)
69	
82	
121	
1.0E+16	556E-08 0.7E-04 6.416E-04 16.956E-04 n _{ch} t _{ox} L _{jun} L _{poly} Z
(3) initia	l starting value file
0.1 5	$00 V_{fb}(i) \mu(i)$
0.1 5	00
0.1 5	00
0.1 5	00

Vfb = -7.590'	70E-01 Mu =	448.10 Vd =
Vg	Id ·	Idcal
0.7000E+00	0.2205E-08	0.8265E-09
0.7500E+00	0.5492E-08	0.3088E-08
0.8000E+00	0.1168E-07	0.1068E-07
0.8500E+00	0.3415E-07	0.3064E-07
0.9000E+00	0.7210E-07	0.8757E-07
0 9500E+00	0.1960E-06	0.2345E-06
0.1000E+01	0.4269E-06	0.5594E-06
0.1050E+01	0 8419E-06	$0.1163E_{-}05$
0.10000+01	0 1380E_05	$0.1415E_{-05}$
0.11000+01	0.1383B-05 0.2331E-05	0.2001E 05
0.1130E+01	0.225310-05	0.20910-03
0.12000+01	0.33030-03	0.20430-03
0.12506+01	0.43186-03	0.30356-05
0.13006+01	0.5754E-05	0.45046-05
0.13506+01	0.70366-05	0.53826-05
0.1400E+01	0.8341E-05	0.6281E-05
0.1450E+01	0.9659E-05	0.7198E-05
0.1500E+01	0.1098E-04	0.8128E-05
0.1550E+01	0.1229E-04	0.9070E-05
0.1600E+01	0.1359E-04	0.1002E-04
0.1650E+01	0.1489E-04	0.1098E-04
0.1700E+01	0.1617E-04	0.1195E-04
0.1750E+01	0.1744E-04	0.1292E-04
0.1800E+01	0.1857E-04	0.1389E-04
0.1850E+01	0.1994E-04	0.1487E-04
0.1900E+01	0.2116E-04	0.1586E-04
$0.1950E \pm 01$	0.2237E-04	0.1685E-04
0.2000E+01	0.2257E-04	0.1784E-04
0.200000+01	0.23370-04	0.17040-04
0.20306+01	0.24700-04	0.10036-04
0.21000+01	0.23936-04	0.19030-04
0.21306+01	0.27096-04	0.20836-04
0.22006+01	0.28236-04	0.21836-04
0.22506+01	0.29366-04	0.2283E-04
0.2300E+01	0.30486-04	0.23846-04
0.2350E+01	0.3159E-04	0.2485E-04
0.2400E+01	0.3268E-04	0.2586E-04
0.2450E+01	0.3377E-04	0.2687E-04
0.2500E+01	0.3484E-04	0.2788E-04
0.2550E+01	0.3590E-04	0.2889E-04
0.2600E+01	0.3695E-04	0.2991E-04
0.2650E+01	0.3799E-04	0.3092E-04
0.2700E+01	0.3902E-04	0.3194E-04
0.2750E+01	0.4004E-04	0.3296E-04
0.2800E+01	0.4105E-04	0.3398E-04
0.2850E+01	0.4205E-04	0.3500E-04
0.2900E+01	0.4304E-04	0.3602E-04
0.2950E+01	0.4403E-04	0.3704E-04
0.3000E+01	0.4500E-04	0.3806E-04
0.3050E+01	0 4597E-04	0.3908E-04
0.3100E+01	0 4603E_04	$0.4011E_{-04}$
0.3150E+01	0 47971 04	0 4113E_04
0.3200F+01	0 4880F 04	0 4216E_04
0.32505.01	0 40757 04	0 42100-04
0 32000-01	0.49/30-04	0.4018 04
0.335000+01	0.50086-04	0.444210-04
0.33506+01	0.51005-04	0.45236-04
0.34000+01	0.52515-04	0.40200-04
0.3450E+01	0.5342E-04	0.47296-04
0.3500E+01	0.5432E-04	0.4832E-04

0.05 Set 1

٠

.

0.3550E+01	0.5521E - 04	0.4935E-04
0 3600 -01	0 56008-04	0 50288-04
0.30000401	0.50030-04	0.30380-04
0.3850E+01	0.5697E-04	0.5141E-04
0.3700E+01	0.5785E-04	0.5244E-04
0.27505.01	0 59798 04	0 52478 04
0.37306+01	0.38726-04	0.33476-04
0.3800E+01	0.5957E-04	0.5450E-04
0 3850E+01	0 6043E-04	0 5553E-04
0.000001.01	0.00101 01	
0.38005+01	0.01286-04	0.30306-04
0.3950E+01	0.6212E-04	0.5760E-04
0 4000	0 6296E-04	0 5863E-04
	0.02308-04	0.00000-04
0.4050E+01	0.63796-04	0.59666-04
0.4100E+01	0.6461E - 04	0.6070E-04
0 4150E+01	0 65438-04	0 61738-04
0.41308+01	0.00438-04	0.01758-04
0.4200E+01	0.6625E-04	0.6276E-04
0.4250E+01	0.6706E-04	0.6380E-04
0 4200 - 01	0 87988 04	0 64945 04
0.43006+01	0.07806-04	0.04846-04
0.4350E+01	0.6867E-04	0.6587E-04
0.4400E+01	0 6946E-04	0.6691E - 04
0.44500.01	0.00101 01	
0.44505+01	0.7025E-04	0.6794E - 04
0.4500E+01	0.7104E-04	0.6898E-04
0 4550E+01	$0.7182E_{-0.4}$	0 7001E-04
0.43306+01	0.71826-04	0.7001E-04
0.4600E+01	0.7259E-04	0.7105E-04
0.4650E+01	0.7337E-04	0.7209E-04
0 4700 - 01	0 7414E 04	0 72125 04
0.4/000+01	0.74140-04	0.73136-04
0.4750E+01	0.7490E-04	0.7416E-04
$0.4800E \pm 01$	0 7565E-04	0 7520E-04
0.40500.01	0.76410.04	0.76948.04
0.48506+01	0.76416-04	0.7624E - 04
0.4900E+01	0.7716E-04	0.7728E-04
0 40508+01	0 77908-04	0 78318-04
0.49306401	0.77900-04	0.78516-04
0.5000E+01	0.7864E - 04	0.7935E-04
0.5050E+01	0.7938E-04	0.8039E-04
0 51000.01	0 90125 04	0 91 42 0 04
0.51006401	0.80126-04	0.81456-04
0.5150E+01	0.8085E-04	0.8247E-04
0.5200E+01	0.8157E-04	0.8351E - 04
0.50508.01		
0.52506+01	0.82296-04	0.84556-04
0.5300E+01	0.8301E-04	0.8559E-04
0 5350E+01	0 8372E-04	0 8663E-04
0.00000000	0.03720-04	0.80030-04
0.5400E+01	0.84435-04	0.8767E-04
0.5450E+01	0.8514E-04	0.8871E - 04
0 55000.01	O SEGAE OA	0 80758-04
0.33000+01	0.83840-04	0.88750-04
0.5550E+01	0.8654E - 04	0.9079E-04
0.5600E+01	0.8723E-04	0.9183E-04
O FREODIOI	0 97028 04	0.02978-04
0.30306+01	0.87920-04	V.9207E-04
0.5700E+01	0.8861E-04	0.9391E-04
0.5750E+01	0.8929E-04	0.9495E-04
0.58000.01	0.00202 01	0.0500E 04
0.58006+01	0.89976-04	0.95996-04
0.5850E+01	0.9065E-04	0.9703E-04
0 59008+01	$0.9132E_{-04}$	0 9808E-04
0.000000001	0.01020-04	
0.59506+01	0.91996-04	0.9912E-04
0.6000E+01	0.9265E-04	0.1002E-03
0 60508+01	0 0332E-04	0 10128-03
	0.00020-04	0.10120-03
0.8100E+01	0.9398E-04	0.1022E-03
0.6150E+01	0.9463E-04	0.1033E-03
0 6200E 01	0 0520F 04	0 10425 02
0.02000101	0.00200-04	0.10450-05
0.6250E+01	0.9594E-04	0.1054E - 03
0.6300E+01	0.9658E-04	0.1064E-03
0 62500.01	0.07225 04	0 10755 02
0.03500+01	0.81230-04	0.10/56-03
0.6400E+01	0.9786E-04	0.1085E-03
0.6450E+01	0.9850E-04	0.1095E-03
O REOOD OI	0.00148.04	0 11060 00
0.00000+01	0.99140-04	0.11006-03

.

.-

•

0.8550E+01	0.9976E-04	0.1116E-03
0.6800E+01	0.1004E-03	0.1127E-03
0.6650E+01	0.1010E-03	0.1137E-03
0.6700E+01	0.1016E-03	0.1148E-03
0.6750E+01	0.1022E-03	0.1158E-03
0.6800E+01	0.1029E-03	0.1168E-03
0.6850E+01	0.1035E-03	0.1179E-03
0.6900E+01	0.1041E-03	0.1189E-03
0.6950E+01	0.1047E-03	0.1200E-03
0.7000E+01	0.1053E-03	0.1210E-03
0.7050E+01	0.1059E-03	0.1221E-03
0.7100E+01	0.1065E-03	0.1231E-03
0.7150E+01	0.1071E-03	0.1242E-03
0.7200E+01	0.1077E-03	0.1252E-03
0.7250E+01	0.1083E-03	0.1262E-03
0.7300E+01	0.1088E-03	0.1273E-03
0.7350E+01.	0.1094E-03	0.1283E-03
0.7400E+01	0.1100E-03	0.1294E-03
0.7450E+01	0.1106E-03	0.1304E-03
0.7500E+01	0.1111E-03	0.1315E-03
0.7550E+01	0.1117E-03	0.1325E-03
0.7600E+01	0.1123E-03	0.1336E-03
0.7650E+01	0.1129E-03	0.1346E-03
0.7700E+01	0.1134E-03	0.1357E-03
0.7750E+01	0.1140E-03	0.1367E-03
0.7800E+01	0.1145E-03	0.1378E-03
0.7850E+01	0.1151E-03	0.1388E-03
0.7900E+01	0.1156E-03	0.1398E-03
0.7950E+01	0.1162E-03	0.1409E-03
0.8000E+01	0.1167E-03	0.1419E-03

.

• .

```
This main program executes a Curve Fit using:
С
С
          STEPIT for the curve fitting
С
          STSET for initialization of STEPIT input parameters
С
С
          MODEL for minimizing the current equation derived
                from a "Charge-Sheet Model"
С
          CSO for main Charge-sheet program
C
          FUNCTION for the current equation
C
С
С
          The user must supply:
c
С
          1. IV data file in required format
С
С
          2. Parameter file in required format
С
С
          3. Initial Starting value file for mobility
С
             and flat band voltage in each data set.
С
С
С
С
          The user can request a copy of STEPIT from:
С
С
С
          Quantum Chemistry Program Exchange
          Indiana University
С
         Bloomington, Indiana 47401
С
С
С
          Authored by: J.P. Chandler
          Department of Computing and Information Sciences
C
          Oklahoma State University
C
          Stillwater, Oklahoma 74074
C
C
C
С
С
          The program CSFIT assumes that the fitting parameters
С
          are flat band voltage and mobility with the flat band
С
          voltage=X(2i-1) and mobility=X(2i) where i=1,2,\ldots
С
          ...nvds=the total number of data sets and 2*nvds=total
С
          number of fitting parameters. Thus, if 2 I-V data sets
С
          are used with X(1)=u1, X(2)=fbv1, X(3)=u2, and X(4)=fbv2
С
          the output file results would be as follows:
С
С
С
c1SUBROUTINE STEPIT.
                     COPYRIGHT (C) 1965 J. P. CHANDLER
C
c INITIAL VALUES....
С
C
c MASK
                0
                            0
                                         0
                                                     0
        =
С
сΧ
            0.10000E+00
                                     0.10000E+00
                                                0.5000E+03
                        0.50000E+03
        =
С
c XMAX
        =
            0.10000E+36 0.10000E+36
                                     0.10000E+36
                                                 0.10000E+36
С
c XMIN
           -0.10000E+36 -0.10000E+36 -0.10000E+36 -0.10000E+36
        =
C
c DELTX
           0.10000E-02 0.50000E+01 0.10000E-02 0.50000E+01
        =
```

```
C
c DELMN
             0.10000E-03 0.10000E-03 0.10000E-03 0.10000E-03
         =
С
С
   4 VARIABLES,
                   4 ACTIVE.
                                        MATRX = 110
                                                               NFMAX = 1000000
С
   NFLAT = 1
                        RELAC = 0.1000E - 16
C
C
C
 FOBJ = 0.5310057276E-08
С
С
C
 BEGIN MINIMIZATION....
С
С
С
С
C
 TERMINATED WHEN THE STEP SIZES BECAME AS SMALL AS THE DELMN(J).
С
C
С
С
   277 FUNCTION COMPUTATIONS
C
C
 FINAL VALUE OF FOBJ = 0.136086974597773E-10
С
C
C
          FINAL VALUES OF X(J)....
С
С
c 0.897635003046762E+00
                           0.538229046900407E+03 0.903491922574461E+00
 0.537289871078474E+03
C
C
 1SUBROUTINE STERR.
С
C
C COMPUTE AN APPROXIMATE ERROR MATRIX USING FINITE DIFFERENCES.
C
C
  INCREMENTS IN X(J) TO BE USED....
C
С
           0.32000E+02 0.20000E+05 0.32000E+02
                                                       0.10000E+05
C
С
C
 SQUARE ROOT OF NEGATIVE NUMBER HAS OCCURRED:
С
C
 EITHER THE INITIAL STARTING VALUES ARE BAD AND NEED TO BE RESET OR
C
C
 THE ERROR MATRIX CAN NOT BE COMPUTED WITH THE CSO ALGORITHM,
С
C
 THUS IGNORE MESSAGE AND ASSUME FITTED VALUES ARE CORRECT.
C
C
С
C
C
C
    Note: The error matrix could not be computed and thus it is
C
          disregarded. When an approximate error matrix is attainable, a matrix of the second partial derivatives,
C
С
          a standard errors matrix, and a lower triangle of the
C
          correlation matrix is given.
C
С
```

```
The final optimized values are given in corresponding order,
          i.e., vfb(1),mob(1),vfb(2),mob(2),.....vfb(i),mob(i).
     implicit real*8 (a-h,o-z)
     external model
     dimension a(1000,3)
     common / cstep / x(20), xmax(20), xmin(20), deltx(20), delmn(20),
    *err(20,21),fobj,nv,ntrac,matrx,mask(20),nfmax,nflat,jvary,
    *nxtra, kflag, norep, kerfl, kw
     common /cmod/ xm(1000),y(1000),npts
     common /input/ npset(20), vds(20), nvds
     real*4 vds, beta
     common /mshape/ djun,ljun,lch
     real*4 djun, ljun, lch
     common /dopant/ nsd,nch
     real*4 nsd, nch
     common /bias/ vd, vs, vg, vsub, vfb
     real*4 vd, vs, vg, vsub, vfb
     common /gate/ tox,q0,kox,ksi
     real*4 tox, q0, kox, ksi
     common /sheet/ mustar, z, psib, lb, cox, psis0, psis1, n0, i0, id
     real*4 mustar, 1b, n0, i0, id, psib, cox, psis0, psis1, z
     COMMON /NORM/ VT, VNORM, Q, NI, EPSO, EPS, LNORM, NNORM, tnorm, muO
     REAL*4 VT, VNORM, Q, NI, EPSO, EPS, LNORM, NNORM, tnorm, muO
     character*40 filin1, filin2, filin3, filout
     write (6,*) 'Enter IV Data file'
     read (5,5) filin1
     format (a)
     write (6,*) 'Enter Parameter file'
     read (5,5) filin2
     write (6,*) 'Enter Initial Starting Value file'
read (5,5) filin3
     write (6,*) 'Enter Output file'
     read (5,5) filout
     open (unit=10, file=filin1, status='old')
     open (unit=11, file=filin2, status='old')
     open (unit=12, file=filin3, status='old')
     open (unit=16, file=filout, status='new')
     open (unit=17, file='plot.dat', status='new')
                Read from the Data file. The following
                format for the data file is required:
                npts
                          a(j,2)
                a(j,1)
                                      a(j,3)
                           npts=total number of iv points
                where:
                           a(j,1)=source-to-drain voltage
                           a(j,2)=gate voltage
                           a(j,3)=drain current
      read(10,*) npts
      do 200 j=1,npts
      read (10,*) a(j,1), a(j,2), a(j,3)
      y(j) = a(j,3)
      xm(j)=a(j,2)
200
      continue
```

С

С С С

С С С С С С С

С

С С

С С

С

26

С

```
Read from the Parameter file. The following
               format is required:
               nvds
               vds(1)
               vds(i)
               npset(1)
               npset(i)
               nch
               tox
               ljun
               lch
               \mathbf{z}
               where:
                        nvds=the number of data sets.
                         vds(i)=source-to-drain voltages for
                                each set.
                         npsets(i)=number of data points in
                                   each set.
                         nch=average channel doping (cm-3)
                         tox=oxide thickness (cm)
                         ljun=lateral source and drain
                              diffusion (cm)
                         lch=drawn length of polysilicon (cm)
                         z=width of channel (cm)
     read (11,*) nvds
     do 201 j1=1,nvds
     read (11,*) vds(j1)
     do 202 j2=1,nvds
202
     read (11,*) npset(j2)
     read (11,*) nch,tox,ljun,lch,z
     q=1.6E-19
     ni=1.5E+10
     nch=nch/ni
     kox=3.9
     ksi=11.8
     eps0=8.854E-14
     mu0=1000
     a0=0.
     vt=.0259
     beta=1.0/vt
     lnorm=sqrt(ksi*eps0/q/(beta*ni))
     tox=tox/lnorm
     ljun=ljun/lnorm
     lch=lch/lnorm
     z=z/lnorm
               Call STSET to initialize starting values for STEPIT.
               See STEPIT documentation for details.
                       STEPIT allows the user to control the least
               Note:
                       squares criterion by setting certain values:
                       x(i)=initial values of the parameters, on which
```

C C C С C C C C C 201

C

С

C С

C

С C

C

C

С С

C

С С С

С

C С С

C

C

С

C

C

C C

C C

С

С

```
С
                             the function to be minimized depends.
                       xmax(i)=the upper limit on the value of x(i).
С
С
                       xmin(i)=the lower limit on the value of x(i).
                        deltx(i)=the initial step by which x(i) is varied.
С
                       delmn(i)=the lower limit (convergence tolerance)
С
С
                                on the step size for x(i).
С
                       mask(i)=set nonzero if x(i) is not to be varied,
С
                               but rather is to be held at its initial
С
                                value.
С
                       ntrac=determines the amount of printout from STEPIT
С
С
                                ntrac=1
                                        to obtain trace during the
С
                                         minimization process
С
С
                                        for initial and file output only
                               ntrac=0
С
С
                               ntrac=-1 for no output except error messages
С
                STSET will set all the above to default values except ntrac
С
С
                After SESET is called the inital starting values are read
С
С
                in via the following format.
C
С
                initial vfb(1)
С
                initial mob(1)
С
                initial vfb(2)
С
                initial mob(2)
С
                ٠
С
С
C
                initial vfb(nvds)
С
                initial mob(nvds)
С
      call stset
      nv=nvds*2
      ntrac=0
      do 203 j3=1,nv,2
      read(12,*) x(j3),x(j3+1)
203
      x(j3+1) = -x(j3+1)
     do 204 j4=1,nv
204
      delmn(j4) = 1.0E - 04
      matrx=110
С
С
            call STEPIT for least squares fit.
С
      call stepit(model)
С
С
     print results
С
     k=1
       do 2000 j=1,nvds
          Vffit = -x(2*j-1)
          1002
    1
          imax=npset(j)
          vd=vds(j)/vt
```

```
vfb=-x(2*j-1)/vt
           mustar = x(2*j)/mu0
           do 1000 i=1, imax
               vg=xm(k)/vt
               call cs0
               write (16, 1001) \times (k), y(k), id
1001
               format (3e12.4)
               write(17,1001) vds(j),xm(k),id
               k=k+1
1000
               continue
2000
        continue
207
      continue
      close(10)
      close(11)
      close(12)
      close(16)
      end
C
C
C
                    MODEL subroutine
C
C
      subroutine model
      implicit real*8 (a-h,o-z)
      common /cstep/ x(20), xmax(20), xmin(20), deltx(20), delmn(20),
     *err(20,21),fobj,nv,ntrac,matrx,mask(20),nfmax,nflat,jvary,
     *nxtra, kflag, norep, kerfl, kw
      common /cmod/ xm(1000),y(1000),npts
      common /input/ npset(20),vds(20),nvds
      real*4 vds, beta
      common /mshape/ djun,ljun,lch
      real*4 djun,ljun,lch
      COMMON /GATE/ TOX,QO,KOX,KSI
      REAL*4 KOX, KSI, tox, q0
      common /dopant/ nsd,nch
      real*4 nsd, nch
      COMMON /NORM/ VT, VNORM, Q, NI, EPSO, EPS, LNORM, NNORM, thorm, muO
      REAL*4 VT, VNORM, Q, NI, EPSO, EPS, LNORM, NNORM, tnorm, muO
      common /bias/ vd,vs,vg,vsub,vfb
      real*4 vd, vs, vg, vsub, vfb
      common /sheet/ mustar, z, psib, lb, cox, psis0, psis1, n0, i0, id
      real*4 mustar, 1b, n0, i0, id, psib, cox, psis0, psis1, z
      real*4 ifun,nl
      fobj=0.
      k=1
        do 2000 j=1,nvds
            imax=npset(j)
            vd=vds(j)/vt
            vfb=-x(2*j-1)/vt
            mustar = x(2*j)/mu0
            do 1000 i=1, imax
               vg=xm(k)/vt
               call cs0
               fobj=fobj+(id/y(k)-1.0)**2
               k=k+1
1000
               continue
2000
         continue
      return
      end
```

CSO Subroutine

```
С
      subroutine cs0
      common /mshape/ djun,ljun,lch
      real*4 djun, ljun, lch
      COMMON /GATE/ TOX, QO, KOX, KSI
      REAL*4 KOX, KSI, tox, q0
      common /dopant/ nsd, nch
      real*4 nsd, nch
      COMMON /NORM/ VT, VNORM, Q, NI, EPSO, EPS, LNORM, NNORM, tnorm, muO
      REAL*4 VT, VNORM, Q, NI, EPSO, EPS, LNORM, NNORM, tnorm, muO
      common /bias/ vd,vs,vg,vsub,vfb
      real*4 vd, vs, vg, vsub, vfb
      common /sheet/ mustar, z, psib, lb, cox, psis0, psis1, n0, i0, id
      real*4 mustar, 1b, n0, i0, id, psib, cox, psis0, psis1, z
      real*4 ifun,nl
      beta = 1.0/vt
      psib = vt*alog(nch)
      lb = sqrt(ksi*eps0/q/(beta*nch*ni))
      cox = kox * eps0/(TOX * LNORM)
      vg1 = vg-vfb+q*beta*Q0/cox
      bps0 = 2.0*beta*psib-2.0*alog(beta*sqrt(2.0)*q*nch*ni*lb/cox)
      bpsi = bps0
      bpsis = 1.0e10
      if (vg1.lt.bps0) bpsis = bps0
      if (vg1.le.bps0) goto 11
      do 10 i=1,500
      bpsi = bps0+alog(abs((vg1-bpsi)**2/(1.+(bpsi-1.0)/exp(bpsi
     1 -2.0*psib*beta))))
      if (abs(bpsi-bpsis).lt.1.e-4) goto 11
      bpsis = bpsi
 10
      continue
 11
      psis0=bpsi/beta
      nO=nch*ni*lb*sqrt(2.)*((bpsi-1.0+(1./nch)**2*
     1
         exp(bpsi))**0.5-(bpsi-1.)**0.5)
      psisl = psis0+vd*vt
      v0 = (q*nch*ni*lb/cox)**2
      IF (VG1.LT. 1.0) GO TO 5000
      psiss=vg1*vt+v0*beta-sqrt((v0*beta)**2+2.*v0*(vg1-1.0))
      if (psisl.gt.psiss) psisl=psiss
      nl = 0.0
      if (psisl.eq.psiss) goto 13
      h = 1.0
      dpold = 1.0
      do 12 i=1,100
      nl = cox*(vg1*vt-psisl)/q-ni*nch*lb*sqrt(2.)*(beta*psisl-1.)**0.5
      if (nl.lt.1.0e-25) nl=1.0e-25
      psisi=psis0+vd*vt+alog(nl/n0)/beta
      delpsi=psisi-psisl
      if (abs(delpsi).gt.vt) delpsi=vt*abs(delpsi)/delpsi
      if (delpsi.eq.0.0) goto 12
      if (dpold/delpsi.lt.0.0) h=h/2.0
      psisl=psisl+h*delpsi
      if (abs(delpsi).lt.1.0e-5) goto 13
      dpold=delpsi
 12
      continue
```

```
30 13 id = ifun(psisl,lch)
```

υυυυ

```
xidot = id*beta**2/(mustar*mu0*z/(lch-2.0*ljun)*cox)
      xlch = lch-2.0*ljun
      WRITE (6,90) BETA, PSIB, LB, COX, BPSO, BPSI, PSISO, NO
С
          ,PSISL,NL, ID, i0, xidot, vg, vd, xlch
     1
C
                   BETA = ', 1PE15.6/
      FORMAT ('
90
          PSIB = ', 1PE15.6/
     1
          COX = ',1PE15.6/
       2
     1
       >
     1
         BPSO = ', 1PE15.6/
BPSI = ', 1PE15.6/
PS(0) = ', 1PE15.6/
NO = ', 1PE15.6/
PS(L) = ', 1PE15.6/
NL = ', 1PE15.6/
                  >
       >
     1
       >
     1
       PS(0) =
     1
       2
     1
       >
     1
                = '
                     ,1PE15.6/
     1
       3
          NL
                  ,1PE15.6/
                 = '
       >
     1
           ID
          I... = ',1PE15.6/
       >
     1
                = ',1PE15.6/
= ',1PE15
       >
     1
          VG = ',1PE15.6/
VSD = ',1PE15.6/
LCH = ',1PE15.6/)
     1
       >
       >
     1
       >
     1
      return
5000
      id = 1.0e - 20
c5000 write (16,500)
      FORMAT (//, 'SQUARE ROOT OF NEGATIVE NUMBER HAS',
500
     1' OCCURRED: '//'EITHER THE INITIAL STARTING',
     1' VALUES ARE BAD AND NEED TO BE RESET OR'
         'THE ERROR MATRIX CAN NOT BE COMPUTED WITH',
     1//
        THE CSO ALGORITHM, '//'THUS IGNORE MESSAGE',
     1'
     1' AND ASSUME FITTED VALUES ARE CORRECT.')
       STOP
С
      return
      end
С
С
С
                 Function Subroutine IFUN
С
С
      real function ifun(ps,y)
      common /mshape/ djun,ljun,lch
      real*4 djun,ljun,lch
      COMMON /GATE/ TOX,QO,KOX,KSI
      REAL*4 KOX,KSI,tox,q0
      common /dopant/ nsd,nch
      real*4 nsd,nch
      COMMON /NORM/ VT, VNORM, Q, NI, EPSO, EPS, LNORM, NNORM, tnorm, muO
      REAL*4 VT, VNORM, Q, NI, EPSO, EPS, LNORM, NNORM, tnorm, muO
      common /bias/ vd,vs,vg,vsub,vfb
      real*4 vd, vs, vg, vsub, vfb
      common /sheet/ mustar, z, psib, lb, cox, psis0, psis1, n0, i0, id
      real*4 mustar, 1b, n0, i0, id, z, psib, cox, psis0, psis1
      real*4 i00,fff
      beta = 1.0/vt
      vg1 = vg-vfb+q*beta*Q0/cox
      if ((y-2.0*ljun).ne.0.0) i00 = 1.0/beta*mustar*mu0*z/(y-2.0*ljun)
fff = cox*(1.0+vg1)*(ps-psis0)-beta/2.*cox*(ps**2-psis0**2)
       fff=fff-q*ni*NCH*lb*sqrt(8.)/3.*((beta*ps-1.)**1.5-(beta*PSISO
       -1.)**1.5)
       fff=fff+q*nch*ni*lb*sqrt(2.)*((beta*ps-1.)**.5-(beta*psis0-1.))
     1
          **.5)
       ifun = i00*fff
```

```
if (ps.eq.psisl) i0=i00
return
end
```

.

.

N85-114A (REV. 2-40)						
U.S. DEPT. OF COMM.	1. PUBLICATION OR	2. Performing Organ. Report No.	3. Publication Date			
BIBLIOGRAPHIC DATA			Manageh and 1005			
SHEET (See instructions)	NBS1R-85/3145		November 1985			
4. TITLE AND SUBTITLE CSFIT: A FORTRAN	Program for Charge-She	eet Model Fitting of MC	OSFET Data			
S AUTHOR(S)						
L. C. Witte						
6. PERFORMING ORGANIZA NATIONAL BUREAU OF S	TION (If joint or other than NBS, STANDARDS ERCE	, see instructions)	7. Contract/Grant No. Subtask X990MXVA, Nork Unit 00059			
WASHINGTON, D.C. 2023	4					
9. SPONSORING ORGANIZAT	TION NAME AND COMPLETE A	DDRESS (Street, City, State, ZIP)				
Defense Nuclear Ag Washington, DC 20	gency 0305					
10. SUPPLEMENTARY NOTE	S					
Document describes a	computer program; SF-185, FIP	S Software Summary, is attached.				
11. ABSTRACT (A 200-word o	r less factual summary of most s	ignificant information. If docume	nt includes a significant			
bibliography or literature survey, mention it here) A FORTRAN program, CSFIT, has been developed for fitting an expression for the current-voltage (I-V) characteristics of a long-channel MOSFET to experimental I-V curves. The one-dimensional charge-sheet model developed by Brews provides the basis for the I-V characteristics. The I-V characteristics given by this model are optimized with respect to a set of experimental data using the flatband voltage and the mobility as the only adjustable parameters. The program is written so that multiple sets of I-V data can be fit simultaneously if desired. The user must supply, in specified formats, a current-voltage data file, a device parameter file, and a starting value file.						
12. KEY WORDS (Six to twelv	e entries; alphabetical order; ca	oitalize only proper names; and se	parate key words by semicolons;			
charge-sheet model parameter extracti	; flatband voltage; I- on	V characteristics; mob	ility; MOSFET;			
13. AVAILABILITY			14. NO. OF			
V ulimited			PRINTED PAGES			
For Official Distributi	ion. Do Not Release to NTIS		38			
Order From Superinten 20402.	ident of Documents, U.S. Governi	ment Printing Office, Washington,	D.C. 15. Price			
X Order From National 1	Technical Information Service (N	TIS), Springfield, VA. 22161	50.05			
			39.95			

01. Summary date 02. Summary print Yr. Mo. Day 85 4 3 04. Software date CSFIT: A Yr. Mo. Day Fitting of	repared by (Name tte (301) le FORTRAN Pr MOSFET Da	and Phone) 921-3621 ogram for Char ta	ge-Sh	eet Model	03.	Summary action New Repla X Previous Intern	n Deletio
06. Short title						CSFIT	
08. Software type 09. Proc	essing mode	10.	General	Applicatio	n area	So	ecific
Automated Data System System Computer Program Subroutine/Module Com	ractive th abination	Computer Systems Support/Utility Scientific/Engineerin Bibliographic/Textua		Management/ Business Process Control Other		MOS Tran Modeling	sistor
11. Submitting organization and addr	ess			12. Technical co	ntact(s) an	d phone	
Gaithersburg, MD 2089	9						
voltage (I-V) characte one-dimensional charge characteristics. The	IT, has be ristics of -sheet mod I-V charac	en developed f a long-channe el developed b teristics give	or fit 1 MOSI y Brev n by	tting an e FET to expension ws provides this model	xpressi eriment s the b are or	on for th al I-V cu asis for ptimized w	e current- rves. The the I-V ith respect
voltage (I-V) characte one-dimensional charge characteristics. The to a set of experiment adjustable parameters. fit simultaneously if voltage data file, a d 14. Keywords charge-sheet model; fl extraction	IT, has be ristics of -sheet mod I-V charac al data us The prog desired. evice para atband vol	en developed f a long-channe el developed by teristics give ing the flatba ram is written The user must meter file, an tage; I-V char	or fit I MOSI by Brew in by f ind vol so th supply id a st	tting an es FET to expense vs provides this model ltage and that mat multips y, in spect tarting values tarting values	xpressi eriment s the b are op the mob le sets ified f lue fil	on for the al I-V cu pasis for otimized w bility as of I-V d formats, a e. MOSFET; j	e current- rves. The the I-V ith respect the only ata can be current-
voltage (I-V) characte one-dimensional charge characteristics. The to a set of experiment adjustable parameters. fit simultaneously if voltage data file, a d 14. Keywords charge-sheet model; fl extraction	IT, has be ristics of -sheet mod I-V charac al data us The prog desired. evice para atband vol	en developed f a long-channe el developed b teristics give ing the flatba ram is written The user must meter file, an tage; I-V char	or find al MOSI by Brew and you a so the supply ad a so	tting an ex FET to expense vs provides this model ltage and the nat multip y, in spect tarting values istics; model	xpressi eriment s the b are op the mob le sets ified fi lue fil	on for the cal I-V cu pasis for otimized w pility as of I-V d formats, a e. MOSFET; p	e current- rves. The the I-V ith respect the only ata can be current-
voltage (I-V) characte one-dimensional charge characteristics. The to a set of experiment adjustable parameters. fit simultaneously if voltage data file, a d 14. Keywords charge-sheet model; fl extraction 15. Computer manufr and model DEC 11/780	IT, has be ristics of -sheet mod I-V charac al data us The prog desired. evice para atband vol	en developed f a long-channe el developed by teristics give ing the flatbar ram is written The user must meter file, an tage; I-V char	or fit I MOSI by Brew and you so the supply ad a star racter: 17. Progra	tting an e: FET to expense vs provides this model ltage and the nat multip y, in spect tarting va istics; mole aming language(s	xpressi eriment s the b are op the mob le sets ified f lue fil	on for the al I-V cu pasis for otimized w oility as of I-V d formats, a de. MOSFET; 1 18. Number of ments 4.	e current- rves. The the I-V ith respect the only ata can be current- parameter source program state 84
<pre>voltage (I-V) characte one-dimensional charge characteristics. The to a set of experiment adjustable parameters. fit simultaneously if voltage data file, a d 14. Keywords charge-sheet model; fl extraction 15. Computer manufr and model DEC 11/780 19. Computer memory requirements</pre>	IT, has be ristics of -sheet mod I-V characa al data us The prog desired. evice para atband vol 16. Computer of VMS 20. Tape drives	en developed f a long-channe el developed by teristics give: ing the flatba ram is written The user must meter file, an tage; I-V char perating system	FORTI 21. Disk/	tting an e: FET to expense vs provides this model ltage and that multip y, in spec: tarting values tarting valu	xpressi eriment s the b are op the mob le sets ified f lue fil	on for the al I-V cu pasis for otimized w ility as of I-V d cormats, a e. MOSFET; 1 18. Number of ments 4. 22. Terminals	e current- rves. The the I-V ith respect the only ata can be current- parameter source program state 84
<pre>voltage (I-V) characte one-dimensional charge characteristics. The to a set of experiment adjustable parameters. fit simultaneously if voltage data file, a d 14. Keywords charge-sheet model; fl extraction 15. Computer manufr and model DEC 11/780 19. Computer memory requirements 40K</pre>	IT, has be ristics of -sheet mod I-V charac al data us The prog desired. evice para atband vol 16. Computer of VMS 20. Tape drives 0	en developed f a long-channe el developed b teristics give ing the flatba ram is written The user must meter file, an tage; I-V char perating system	or fit or fit of MOSI by Brev in by f ind vol so th supply d a st acter: 17. Progr FORTH 21. Disk/ 1	tting an e: FET to expense vs provides this model ltage and the nat multip y, in spec: tarting va istics; mole aming language(s RAN Drum units	xpressi eriment s the b are op the mob le sets ified fi lue fil	on for the cal I-V cu pasis for otimized w pility as of I-V d formats, a ce. MOSFET; 1 18. Number of ments 4. 22. Terminals	e current- rves. The the I-V ith respect the only ata can be current- parameter source program state 84
<pre>voltage (I-V) characte one-dimensional charge characteristics. The to a set of experiment adjustable parameters. fit simultaneously if voltage data file, a d 14. Keywords charge-sheet model; fl extraction 15. Computer manufr and model DEC 11/780 19. Computer memory requirements 40K 23. Other operational requirements Requires local vector-</pre>	IT, has be ristics of -sheet mod I-V characa al data us The prog desired. evice para atband vol 16. Computer of VMS 20. Tape drives 0 oriented g	en developed f a long-channe el developed by teristics give ing the flatbar ram is written The user must meter file, and tage; I-V char perating system	or fit I MOSI by Brev an by f and voi so th supply d a si facter: FORTH 21. Disk/ 1	tting an e: FET to expension vs provides this model ltage and the nat multip y, in spect tarting values (stics; mole aming language(s RAN Drum units	xpressi eriment s the b are op the mob le sets ified fi lue fil	on for the sal I-V cultures of the sal I-V cultures for the sal of	e current- rves. The the I-V ith respect the only ata can be current- parameter source program state 84
<pre>voltage (I-V) characte one-dimensional charge characteristics. The to a set of experiment adjustable parameters. fit simultaneously if voltage data file, a d 14. Keywords charge-sheet model; fl extraction 15. Computer manufr and model DEC 11/780 19. Computer memory requirements 40K 23. Other operational requirements Requires local vector- 24. Software availability</pre>	IT, has be ristics of -sheet mod I-V characa al data us The prog desired. evice para atband vol 16. Computer of VMS 20. Tape drives 0 oriented g	en developed f a long-channe el developed by teristics give ing the flatba ram is written The user must meter file, an tage; I-V char perating system	or fit I MOSI by Brew and you so the supply ad a st forter: FORTH 21. Disk/ 1	tting an e: FET to expense vs provides this model ltage and the nat multip y, in spect tarting value istics; mode aming language(s RAN Drum units	xpressi eriment s the b are op the mob le sets ified f lue fil pility;	on for the al I-V cu pasis for otimized w ility as of I-V d formats, a de. MOSFET; 18. Number of ments 4. 22. Terminals 1	e current- rves. The the I-V ith respect the only ata can be current- parameter source program state 84
<pre>voltage (I-V) characte one-dimensional charge characteristics. The to a set of experiment adjustable parameters. fit simultaneously if voltage data file, a d 14. Keywords charge-sheet model; fl extraction 15. Computer manufr and model DEC 11/780 19. Computer memory requirements 40K 23. Other operational requirements Requires local vector- 24. Software availability Available Limit X</pre>	IT, has be ristics of -sheet mod I-V characa al data us The prog desired. evice para atband vol 16. Computer of VMS 20. Tape drives 0 oriented g	en developed f a long-channe el developed by teristics give: ing the flatba ram is written The user must meter file, an tage; I-V char perating system	or fit I MOSI by Brew in by find on by find supply id a st acter: 17. Progra FORTI 21. Disk/ 1	tting an e: FET to expense vs provides this model ltage and the nat multip y, in spec: tarting value istics; mole aming language(s RAN Drum units	<pre>xpressi eriment s the b are op the mob le sets ified f lue fil oility;) ///////////////////////////////////</pre>	on for the al I-V cu pasis for otimized w ility as of I-V d cormats, a e. MOSFET; 18. Number of ments 4. 22. Terminals 1	e current- rves. The the I-V ith respect the only ata can be current- parameter source program state 84

•

• •

-

•

-